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Integrated 4-, 6- and 8-channel passive EMI-filter network with high-level ESD protection

Rev. 1 — 5 May 2011

Product data sheet

1. Product profile

1.1 General description

The IP3253/IP3254-TTL family consists of 4-, 6- and 8-channel LC low-pass filter arrays designed to filter unwanted RF signals on the I/O ports of portable communication and computing devices. In addition, the IP3253/IP3254-TTL family incorporates diodes which protect downstream components from ElectroStatic Discharge (ESD) voltages up to \pm 15 kV.

These devices are fabricated using monolithic silicon technology integrating up to 8 inductors and 16 diodes in a 0.4 mm pitch 8-, 12- or 16-pin ultra-thin leadless Quad Flat No-leads (QFN) plastic package.

1.2 Features and benefits

- Pb-free, Restriction of Hazardous Substances (RoHS) compliant and free of halogen and antimony (Dark Green compliant)
- 4-, 6- and 8-channel integrated π -type LC filter network
- ESD protection to ±15 kV contact discharge according to IEC 61000-4-2, level 4
- ESD protection to ±30 kV contact discharge according to MIL-STD-883 (method 3015) Human Body Model (HBM)
- QFN plastic package with 0.4 mm pitch and 0.5 mm height

1.3 Applications

- General-purpose ElectroMagnetic Interference (EMI), Radio-Frequency Interference (RFI) filtering and downstream ESD protection for:
 - Cellular phone and Personal Communication System (PCS) mobile handsets
 - Cordless telephones
 - Wireless data (WAN/LAN) systems



Integrated 4-, 6- and 8-channel passive EMI-filter network

2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
IP3253CZ8-	4-TTL; IP3254C2	Z8-4-TTL (SOT1166-1)	
1 and 8	filter channel 1		
2 and 7	filter channel 2	- <u>8 5</u> סטטטן	Ls(ch) 1, 2, 3, 4 — 5, 6, 7, 8
3 and 6	filter channel 3		\star \star
4 and 5	filter channel 4		
ground pad	ground	Transparent top view	,,, GND 001aaj745
IP3253CZ12	2-6-TTL; IP32540	Z12-6-TTL (SOT1167-1)	
1 and 12	filter channel 1	- 10 7	
2 and 11	filter channel 2		1, 2, 3, 7, 8, 9,
3 and 10	filter channel 3		4, 5, 6
4 and 9	filter channel 4		TT
5 and 8	filter channel 5	Transparent top view	/→ GND 001aaj746
6 and 7	filter channel 6		
ground pad	ground		
IP3253CZ1	6-8-TTL; IP32540	CZ16-8-TTL (SOT1168-1)	
1 and 16	filter channel 1	10	
2 and 15	filter channel 2		Ls(ch) 1, 2, 3, 4,
3 and 14	filter channel 3		5, 6, 7, 8
4 and 13	filter channel 4		
5 and 12	filter channel 5	Transparent top view	, , , , , , , , , , , , , , , , , , ,
6 and 11	filter channel 6		
7 and 10	filter channel 7		
8 and 9	filter channel 8		
ground pad	ground		

IP3253_IP3254-TTL Product data sheet Integrated 4-, 6- and 8-channel passive EMI-filter network

3. Ordering information

Table 2. Ordering	g information					
Type number	Package					
	Name	Description	Version			
IP3253CZ8-4-TTL	HUSON8	plastic, thermal enhanced ultra thin small outline package; no leads; 8 terminals; body $1.35 \times 1.7 \times 0.55$ mm	SOT1166-1			
IP3253CZ12-6-TTL	HUSON12	plastic, thermal enhanced ultra thin small outline package; no leads; 12 terminals; body 1.35 \times 2.5 \times 0.55 mm	SOT1167-1			
IP3253CZ16-8-TTL	HUSON16	plastic, thermal enhanced ultra thin small outline package; no leads; 16 terminals; body 1.35 \times 3.3 \times 0.55 mm	SOT1168-1			
IP3254CZ8-4-TTL	HUSON8	plastic, thermal enhanced ultra thin small outline package; no leads; 8 terminals; body $1.35\times1.7\times0.55$ mm	SOT1166-1			
IP3254CZ12-6-TTL	HUSON12	plastic, thermal enhanced ultra thin small outline package; no leads; 12 terminals; body 1.35 \times 2.5 \times 0.55 mm	SOT1167-1			
IP3254CZ16-8-TTL	HUSON16	plastic, thermal enhanced ultra thin small outline package; no leads; 16 terminals; body 1.35 \times 3.3 \times 0.55 mm	SOT1168-1			

4. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+5.6	V
V_{ESD}	electrostatic discharge voltage	all pins to ground; contact discharge				
		HBM; MIL-STD-883, method 3015		-	±30	kV
		IEC 61000-4-2, level 4	<u>[1]</u>	-	±15	kV
I _{ch}	channel current (DC)	$T_{amb} = 85 \ ^{\circ}C$		-	30	mA
P _{ch}	channel power dissipation			-	10	mW
P _{tot} /pack	total power dissipation per package	T _{amb} = 85 °C		-	500	mW
T _{stg}	storage temperature			-65	+150	°C
T _{amb}	ambient temperature			-40	+85	°C

 Device tested with 1000 pulses of ±15 kV contact discharges, according to the IEC 61000-4-2 model, far exceeding IEC 61000-4-2 level 4 (8 kV contact discharge).

Integrated 4-, 6- and 8-channel passive EMI-filter network

5. Characteristics

	Table 4. $T_{amb} = 25$	Channel characteristics						
	Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$\begin{tabular}{ c c c c c } \hline F_{I} = 100 \ kHz & f_{I} = 100 \ kHz & f_{I} = 100 \ kHz & IP3253CZx-y-TTL & V_{bias(DC)} = 2.5 \ V & 20 & 25 & 28.2 \ pF & V_{bias(DC)} = 0 \ V & 34 & 43 & 48 \ pF & IP3254CZx-y-TTL & V_{bias(DC)} = 2.5 \ V & 25 & 33 & 40 \ pF & V_{bias(DC)} = 0 \ V & 38 & 50 & 60 \ pF & V_{bias(DC)} = 0 \ V & 38 & 50 & 60 \ pF & ILR & reverse leakage current & per channel; V_{I} = 3.5 \ V & - & - & 0.1 \ \muA & V_{BR} & breakdown voltage & positive clamp; I_{I} = 1 \ mA & 5.8 \ - & 10 \ V & V_{F} & forward voltage & negative clamp; I_{I} = 1 \ mA & 5.8 \ - & -0.4 \ V & I_{F} = -1 \ mA & II &$	$L_{s(ch)}$	channel series inductance			-	18	-	nH
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	C _{ch}	channel capacitance		[1]				
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$		IP3253CZx-y-TTL	$V_{bias(DC)} = 2.5 V$		20	25	28.2	pF
$\begin{tabular}{ c c c c c c c } \hline V_{bias(DC)} = 0 V & 38 & 50 & 60 & pF \\ \hline I_{LR} & reverse leakage current & per channel; V_I = 3.5 V & - & - & 0.1 & \mu A \\ \hline V_{BR} & breakdown voltage & positive clamp; I_I = 1 mA & 5.8 & - & 10 & V \\ \hline V_F & forward voltage & negative clamp; & -1.5 & - & -0.4 & V \\ \hline I_F = -1 mA & & & & & \\ \hline R_{(ch-ch)} & resistance between & V_I = 3.5 V & 10 & - & & & M\Omega \\ \hline \end{array}$			$V_{bias(DC)} = 0 V$		34	43	48	pF
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $		IP3254CZx-y-TTL	$V_{bias(DC)} = 2.5 V$		25	33	40	pF
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $			$V_{bias(DC)} = 0 V$		38	50	60	pF
$ \begin{array}{c} V_{F} & \text{forward voltage} & \text{pectre champ; } I_{I} = 1.04 & \text{visc} & 1.0 & \text{visc} $	I _{LR}	reverse leakage current	per channel; $V_I = 3.5 V$		-	-	0.1	μA
$\frac{1}{I_{F}} = -1 \text{ mA}$	V_{BR}	breakdown voltage	positive clamp; $I_I = 1 \text{ mA}$		5.8	-	10	V
channels	V _F	forward voltage	•		-1.5	-	-0.4	V
$R_{s(ch)}$ channel series resistance - 8 - Ω	$R_{(ch-ch)}$		V ₁ = 3.5 V		10	-	-	MΩ
	R _{s(ch)}	channel series resistance			-	8	-	Ω

[1] Guaranteed by design.

Table 5. Frequency characteristics

$T_{amb} = 25 \ ^{\circ}C \ unless \ other$	wise specified.
---	-----------------

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
α_{il}	insertion loss	${ m R}_{ m source}$ = 50 $\Omega; { m R}_{ m L}$ = 50 $\Omega;$ 1 GHz < f _i < 4 GHz	-	30	-	dB
f _{–3dB}	cut-off frequency					
	IP3253CZx-y-TTL		-	175	-	MHz
	IP3254CZx-y-TTL		-	145	-	MHz
f _{rolloff}	roll-off frequency		<u>1]</u>			
	IP3253CZx-y-TTL		-	350	-	MHz
	IP3254CZx-y-TTL		-	315	-	MHz

[1] Measured at 6 dB attenuation.

IP3253_IP3254-TTL Product data sheet

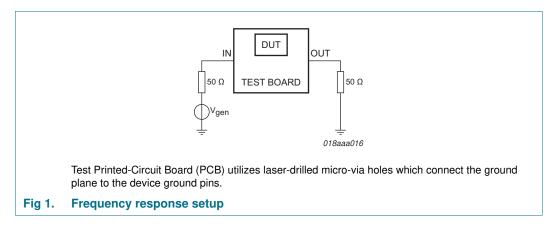
Integrated 4-, 6- and 8-channel passive EMI-filter network

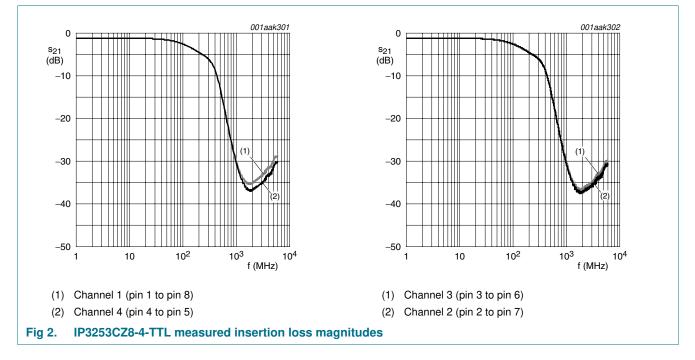
6. Application information

6.1 Insertion loss

The devices are specifically designed as EMI/RFI filters for multichannel interfaces.

The block schematic for measuring insertion loss in a 50 Ω system is shown in Figure 1. An example of the measurement curves for all channels is shown in Figure 2.

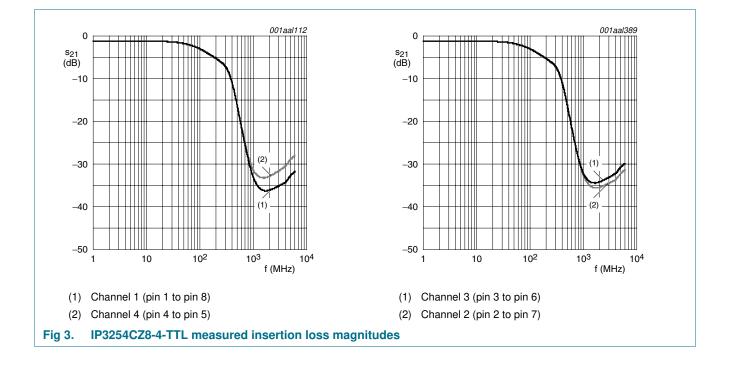




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7. Package outline

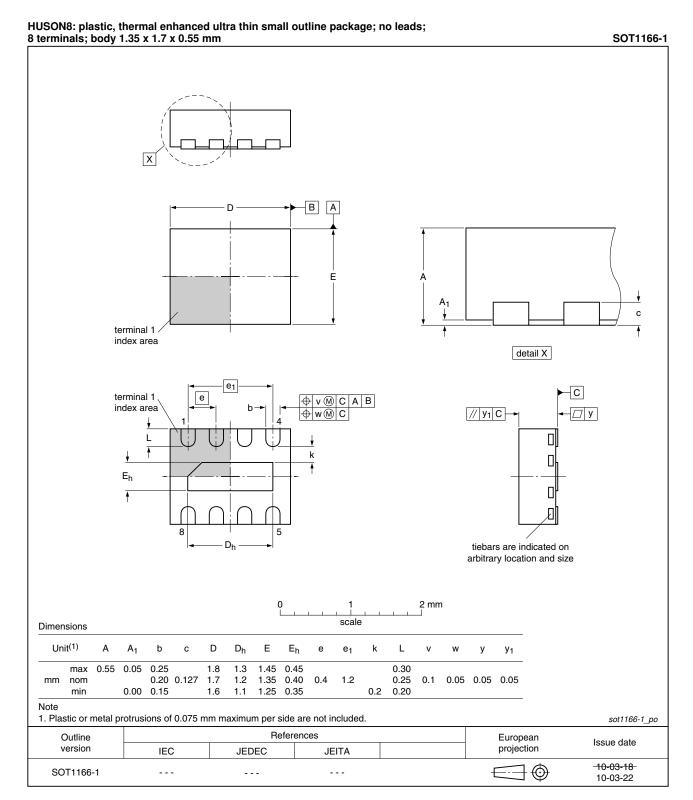
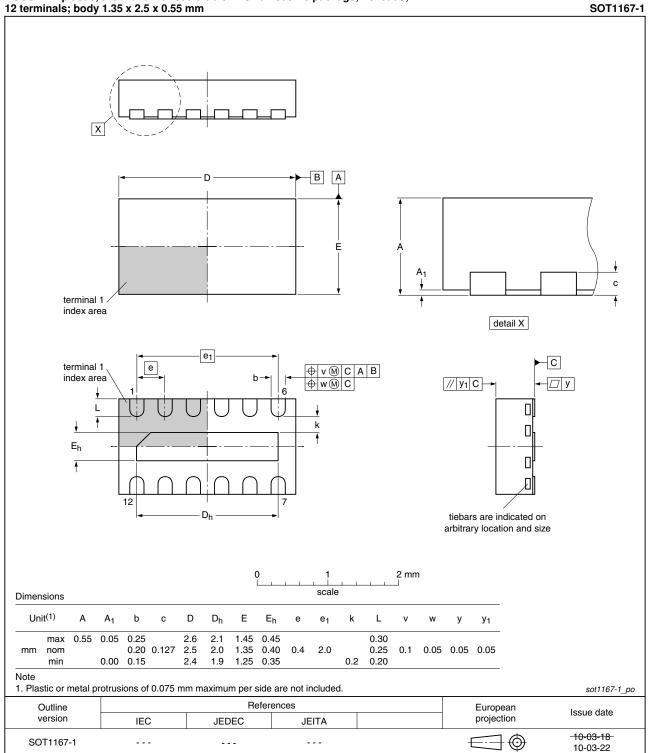


Fig 4. Package outline SOT1166-1 (HUSON8)

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IP3253_IP3254-TTL

Integrated 4-, 6- and 8-channel passive EMI-filter network



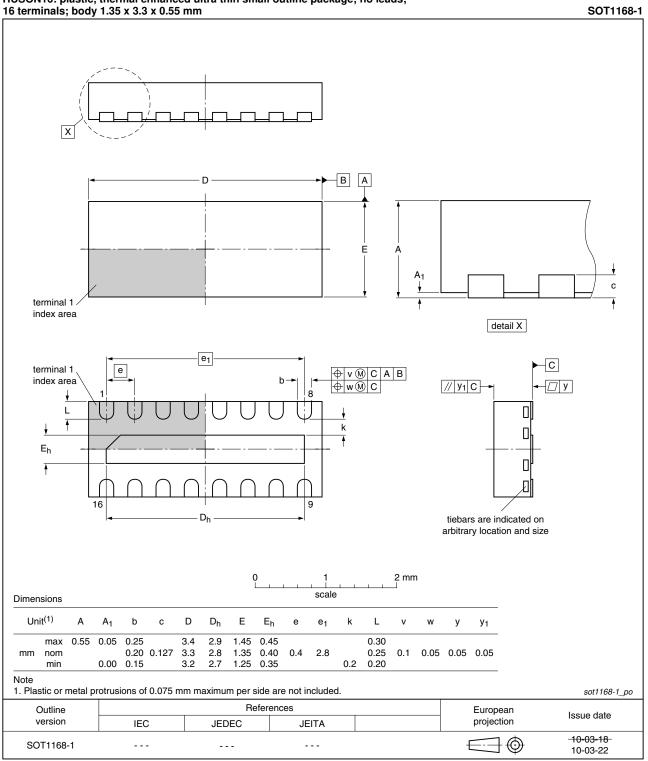
HUSON12: plastic, thermal enhanced ultra thin small outline package; no leads; 12 terminals; body 1.35 x 2.5 x 0.55 mm

Package outline SOT1167-1 (HUSON12) Fig 5.

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HUSON16: plastic, thermal enhanced ultra thin small outline package; no leads;

Package outline SOT1168-1 (HUSON16) Fig 6.

Integrated 4-, 6- and 8-channel passive EMI-filter network

8. Revision history

Table 6. Revision hist	Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
IP3253_IP3254-TTL v.1	20110505	Product data sheet	-	-	

9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Integrated 4-, 6- and 8-channel passive EMI-filter network

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